

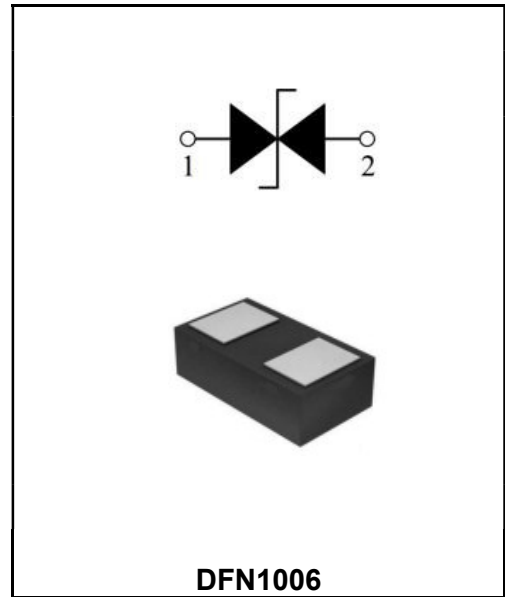
**Bi-directional ESD Protection Diode**

**Features**

- ◆Capacitance: 0.4pF(Max.)
- ◆Reverse Working Voltage: 5V
- ◆IEC 61000-4-2(ESD Air): ± 20KV
- ◆IEC 61000-4-2(ESD Contact): ± 20kV
- ◆IEC61000-4-5(Lightning 8/20us): 5A

**Application**

- ◆Cell Phone Handsets and Accessories
- ◆Microprocessor based equipment
- ◆Personal Digital Assistants
- ◆Notebooks, Desktops, Servers
- ◆Peripherals



**Order Information**

Part Number	Package	Marking	Size (mm)	Delivery Form	Delivery Quantity
ESD1006B5V0E	DFN1006	5E	1.00x0.60x0.40	7" T&R	10000PCS/Tape

**Limiting Values(TA = 25 °C, unless otherwise specified)**

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>PP</sub>	Peak Pulse Power	tP = 8/20 μs	-	100	W
I <sub>PPM</sub>	Rated Peak Pulse Current	tP = 8/20 μs	-	5	A
T <sub>A</sub>	Operating Temperature Range	-	-55	125	°C
T <sub>stg</sub>	Storage Temperature Range	-	-55	150	°C

**Electrical Characteristics(TA = 25 °C unless otherwise specified)**

Symbol	Parameter	Conditions	Min	Typ.	Max	Unit
V <sub>RWM</sub>	Reverse Working Voltage	TA = 25 °C	-	5.0	5.5	V
V <sub>BR</sub>	Breakdown Voltage	IR = 1mA; TA = 25 °C	5.6	-	-	V
I <sub>R</sub>	Reverse Leakage Current	VRWM = 5 V; TA = 25 °C	-	-	1	uA
V <sub>C</sub>	Clamping Voltage	IPP=1A, tP =8/20μs	-	-	12	V
		IPP=5A, tP =8/20μs	-	24	26	V
C <sub>J</sub>	Junction Capacitance	VR = 1V, f = 1 MHz	-	-	4.0	pF

Typical Characteristics

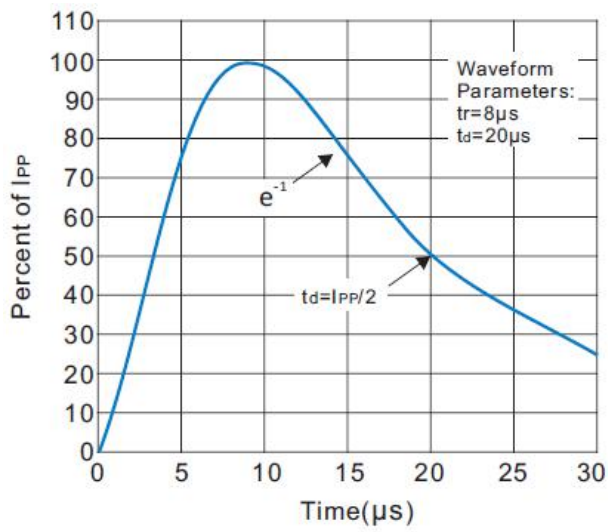


Fig.1 Pulse Waveform

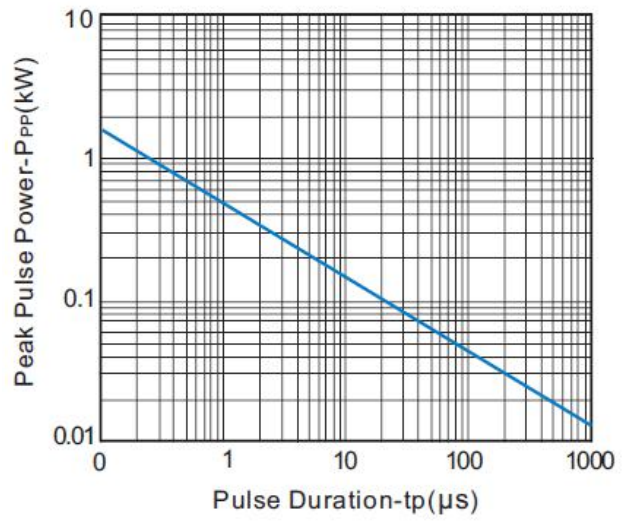
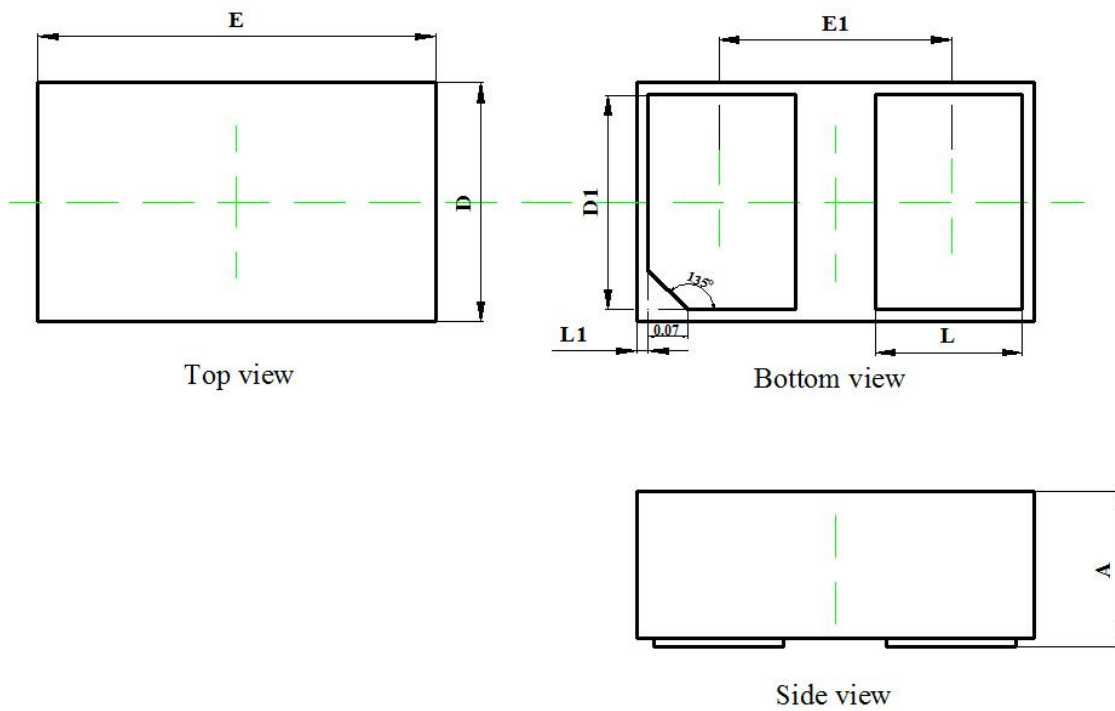


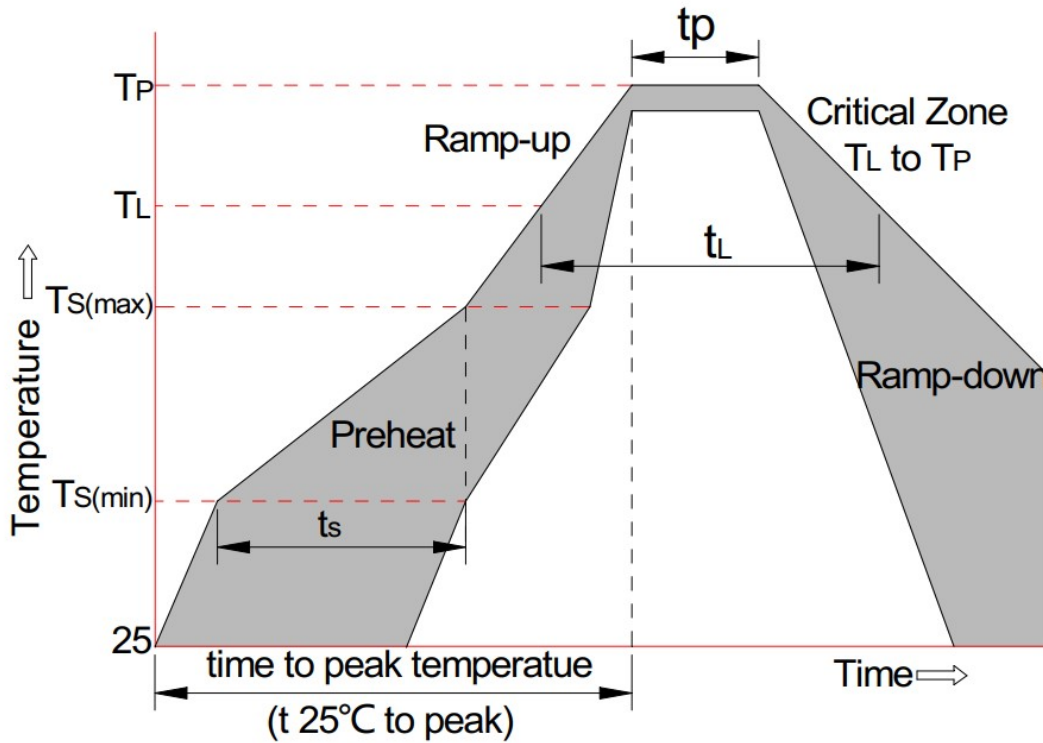
Fig.2 Non-Repetitive Peak Pulse vs. Pulse Time

Package Dimension

DFN1006 Package Outline



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.350	0.450	0.014	0.018
D	0.550	0.650	0.022	0.026
E	0.950	1.050	0.037	0.041
D1	0.420	0.520	0.017	0.020
E1	0.550	0.650	0.022	0.026
L	0.270	0.370	0.011	0.015
L1	0.000	0.100	0.000	0.004



Reflow Condition		Pb-Free Assembly
Pre-heat	-Temperature Min ( $T_{S(min)}$ )	+150°C
	-Temperature Max( $T_{S(max)}$ )	+200°C
	-Time (Min to Max) ( $t_s$ )	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{S(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ )(Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
xTime 25°C to Peak Temp ( $T_P$ )		8 min. Max
Do not exceed		+260°C